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Details

Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	25MHz
Connectivity	UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	33
Program Memory Size	16KB (8K x 16)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	454 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-QFP
Supplier Device Package	44-MQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic17c44t-25-pq

3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC17C4X can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC17C4X uses a modified Harvard architecture. This architecture has the program and data accessed from separate memories. So the device has a program memory bus and a data memory bus. This improves bandwidth over traditional von Neumann architecture, where program and data are fetched from the same memory (accesses over the same bus). Separating program and data memory further allows instructions to be sized differently than the 8-bit wide data word. PIC17C4X opcodes are 16-bits wide, enabling single word instructions. The full 16-bit wide program memory bus fetches a 16-bit instruction in a single cycle. A two-stage pipeline overlaps fetch and execution of instructions. Consequently, all instructions execute in a single cycle (121 ns @ 33 MHz), except for program branches and two special instructions that transfer data between program and data memory.

The PIC17C4X can address up to 64K x 16 of program memory space.

The **PIC17C42** and **PIC17C42A** integrate 2K x 16 of EPROM program memory on-chip, while the **PIC17CR42** has 2K x 16 of ROM program memory on-chip.

The **PIC17C43** integrates 4K x 16 of EPROM program memory, while the **PIC17CR43** has 4K x 16 of ROM program memory.

The **PIC17C44** integrates 8K x 16 EPROM program memory.

Program execution can be internal only (microcontroller or protected microcontroller mode), external only (microprocessor mode) or both (extended microcontroller mode). Extended microcontroller mode does not allow code protection.

The PIC17CXX can directly or indirectly address its register files or data memory. All special function registers, including the Program Counter (PC) and Working Register (WREG), are mapped in the data memory. The PIC17CXX has an orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any addressing mode. This symmetrical nature and lack of 'special optimal situations' make programming with the PIC17CXX simple yet efficient. In addition, the learning curve is reduced significantly.

One of the PIC17CXX family architectural enhancements from the PIC16CXX family allows two file registers to be used in some two operand instructions. This allows data to be moved directly between two registers without going through the WREG register. This increases performance and decreases program memory usage.

The PIC17CXX devices contain an 8-bit ALU and working register. The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between data in the working register and any register file.

The ALU is 8-bits wide and capable of addition, subtraction, shift, and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature.

The WREG register is an 8-bit working register used for ALU operations.

All PIC17C4X devices (except the PIC17C42) have an 8 x 8 hardware multiplier. This multiplier generates a 16-bit result in a single cycle.

Depending on the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. The C and DC bits operate as a borrow and digit borrow out bit, respectively, in subtraction. See the **SUBLW** and **SUBWF** instructions for examples.

Although the ALU does not perform signed arithmetic, the Overflow bit (OV) can be used to implement signed math. Signed arithmetic is comprised of a magnitude and a sign bit. The overflow bit indicates if the magnitude overflows and causes the sign bit to change state. Signed math can have greater than 7-bit values (magnitude), if more than one byte is used. The use of the overflow bit only operates on bit6 (MSb of magnitude) and bit7 (sign bit) of the value in the ALU. That is, the overflow bit is not useful if trying to implement signed math where the magnitude, for example, is 11-bits. If the signed math values are greater than 7-bits (15-, 24- or 31-bit), the algorithm must ensure that the low order bytes ignore the overflow status bit.

Care should be taken when adding and subtracting signed numbers to ensure that the correct operation is executed. Example 3-1 shows an item that must be taken into account when doing signed arithmetic on an ALU which operates as an unsigned machine.

EXAMPLE 3-1: SIGNED MATH

Hex Value	Signed Value Math	Unsigned Value Math
FFh	-127	255
+ 01h	+ 1	+ 1
= ?	= -126 (FEh)	= 0 (00h); Carry bit = 1

Signed math requires the result in REG to be FEh (-126). This would be accomplished by subtracting one as opposed to adding one.

Simplified block diagrams are shown in Figure 3-1 and Figure 3-2. The descriptions of the device pins are listed in Table 3-1.

3.1 Clocking Scheme/Instruction Cycle

The clock input (from OSC1) is internally divided by four to generate four non-overlapping quadrature clocks, namely Q1, Q2, Q3, and Q4. Internally, the program counter (PC) is incremented every Q1, and the instruction is fetched from the program memory and latched into the instruction register in Q4. The instruction is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow are shown in Figure 3-3.

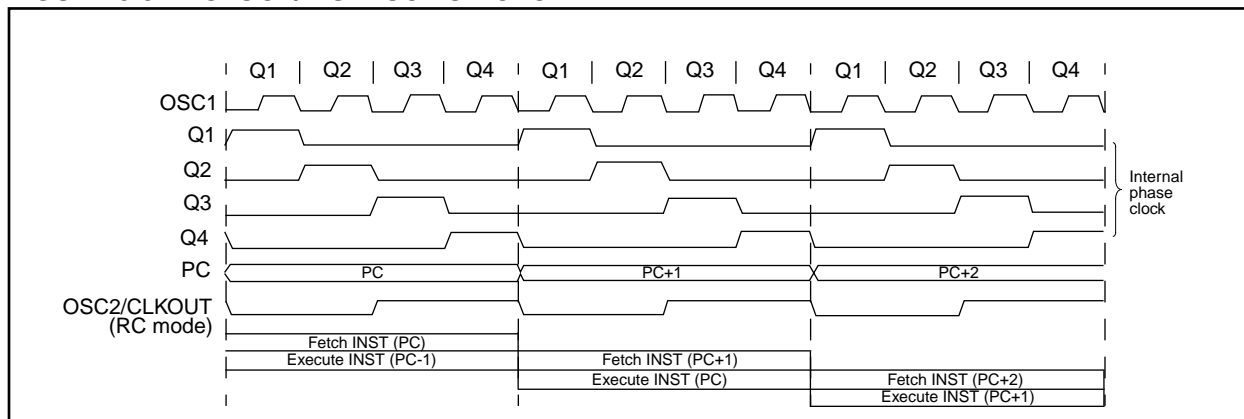
3.2 Instruction Flow/Pipelining

An "Instruction Cycle" consists of four Q cycles (Q1, Q2, Q3, and Q4). The instruction fetch and execute are pipelined such that fetch takes one instruction cycle while decode and execute takes another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change (e.g. GOTO) then two cycles are required to complete the instruction (Example 3-2).

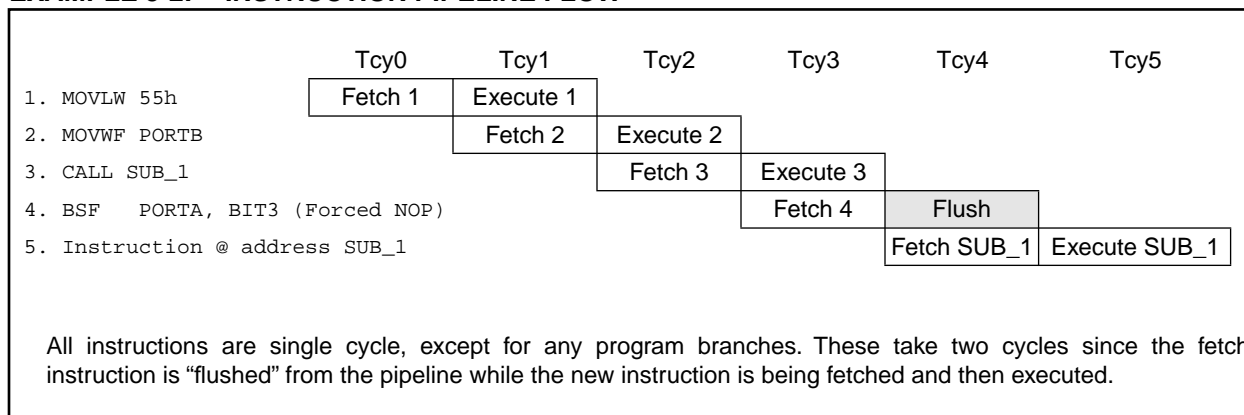
A fetch cycle begins with the program counter incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the "Instruction Register (IR)" in cycle Q1. This instruction is then decoded and executed during the Q2, Q3, and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).

FIGURE 3-3: CLOCK/INSTRUCTION CYCLE



EXAMPLE 3-2: INSTRUCTION PIPELINE FLOW



9.4 PORTD and DDRD Registers

PORTD is an 8-bit bi-directional port. The corresponding data direction register is DDRD. A '1' in DDRD configures the corresponding port pin as an input. A '0' in the DDRC register configures the corresponding port pin as an output. Reading PORTD reads the status of the pins, whereas writing to it will write to the port latch. PORTD is multiplexed with the system bus. When operating as the system bus, PORTD is the high order byte of the address/data bus (AD15:AD8). The timing for the system bus is shown in the Electrical Characteristics section.

Note: This port is configured as the system bus when the device's configuration bits are selected to Microprocessor or Extended Microcontroller modes. In the two other microcontroller modes, this port is a general purpose I/O.

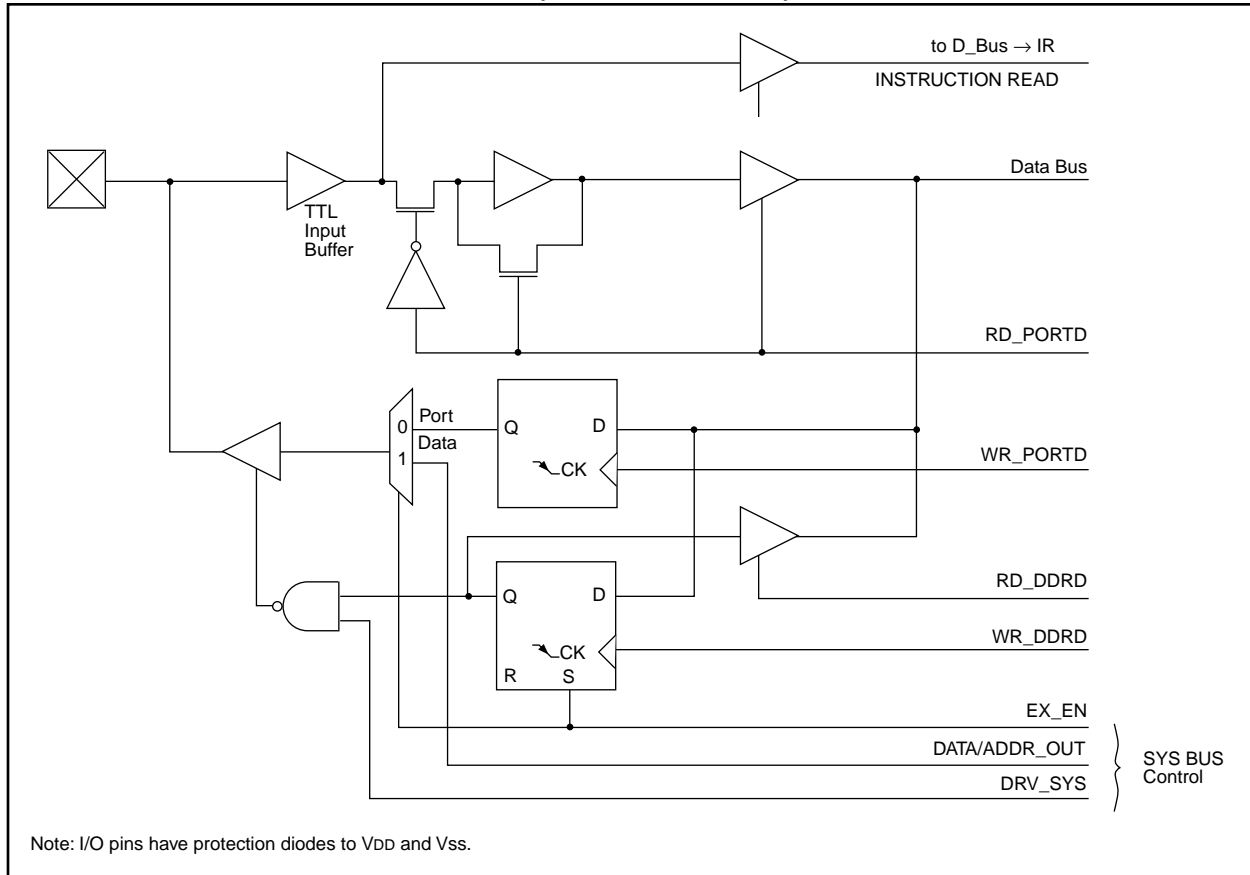
Example 9-3 shows the instruction sequence to initialize PORTD. The Bank Select Register (BSR) must be selected to Bank 1 for the port to be initialized.

EXAMPLE 9-3: INITIALIZING PORTD

```

MOVLB 1           ; Select Bank 1
CLRF  PORTD       ; Initialize PORTD data
                  ; latches before setting
                  ; the data direction
                  ; register
MOVLW 0xCF        ; Value used to initialize
                  ; data direction
MOVWF DDRD        ; Set RD<3:0> as inputs
                  ; RD<5:4> as outputs
                  ; RD<7:6> as inputs
    
```

FIGURE 9-7: PORTD BLOCK DIAGRAM (IN I/O PORT MODE)



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NOTES:

FIGURE 11-5: TMR0 READ/WRITE IN TIMER MODE

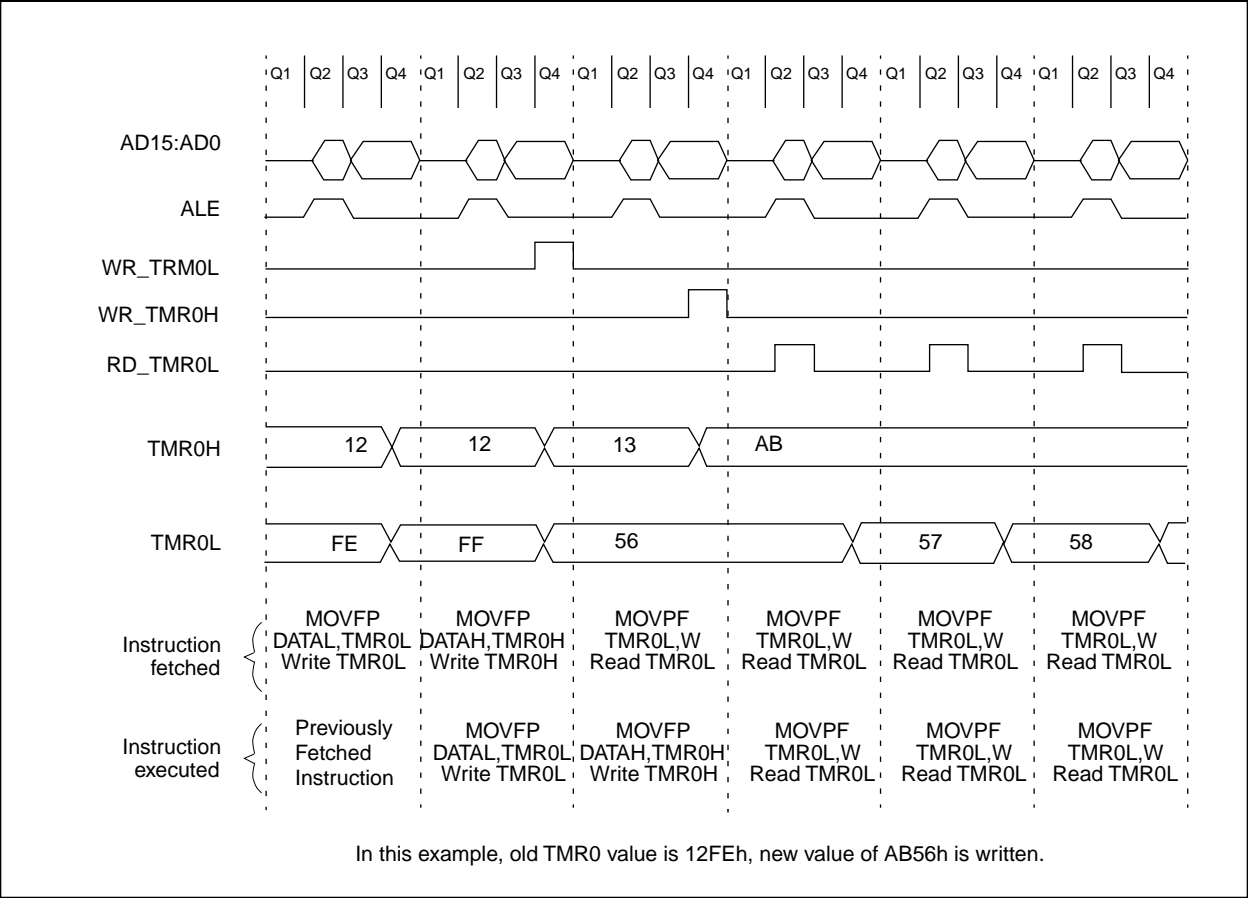


TABLE 11-1: REGISTERS/BITS ASSOCIATED WITH TIMER0

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
05h, Unbanked	T0STA	INTEDG	T0SE	T0CS	PS3	PS2	PS1	PS0	—	0000 000—	0000 000—
06h, Unbanked	CPUSTA	—	—	STKAV	GLINTD	$\overline{\text{TO}}$	$\overline{\text{PD}}$	—	—	--11 11--	--11 qq--
07h, Unbanked	INTSTA	PEIF	T0CKIF	T0IF	INTF	PEIE	T0CKIE	T0IE	INTE	0000 0000	0000 0000
0Bh, Unbanked	TMR0L	TMR0 register; low byte								xxxx xxxx	uuuu uuuu
0Ch, Unbanked	TMR0H	TMR0 register; high byte								xxxx xxxx	uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented read as a '0', q - value depends on condition, Shaded cells are not used by Timer0.
Note 1: Other (non power-up) resets include: external reset through MCLR and the Watchdog Timer Reset.

12.2.2 DUAL CAPTURE REGISTER MODE

This mode is selected by setting CA1/PR3. A block diagram is shown in Figure 12-8. In this mode, TMR3 runs without a period register and increments from 0000h to FFFFh and rolls over to 0000h. The TMR3 interrupt Flag (TMR3IF) is set on this roll over. The TMR3IF bit must be cleared in software.

Registers PR3H/CA1H and PR3L/CA1L make a 16-bit capture register (Capture1). It captures events on pin RB0/CAP1. Capture mode is configured by the CA1ED1 and CA1ED0 bits. Capture1 Interrupt Flag bit (CA1IF) is set on the capture event. The corresponding interrupt mask bit is CA1IE. The Capture1 Overflow Status bit is CA1OVF.

The Capture2 overflow status flag bit is double buffered. The master bit is set if one captured word is already residing in the Capture2 register and another "event" has occurred on the RB1/CA2 pin. The new event will not transfer the TMR3 value to the capture register which protects the previous unread capture value. When the user reads both the high and the low bytes (in any order) of the Capture2 register, the master overflow bit is transferred to the slave overflow bit (CA2OVF) and then the master bit is reset. The user can then read TCON2 to determine the value of CA2OVF.

The operation of the Capture1 feature is identical to Capture2 (as described in Section 12.2.1).

FIGURE 12-8: TIMER3 WITH TWO CAPTURE REGISTERS BLOCK DIAGRAM

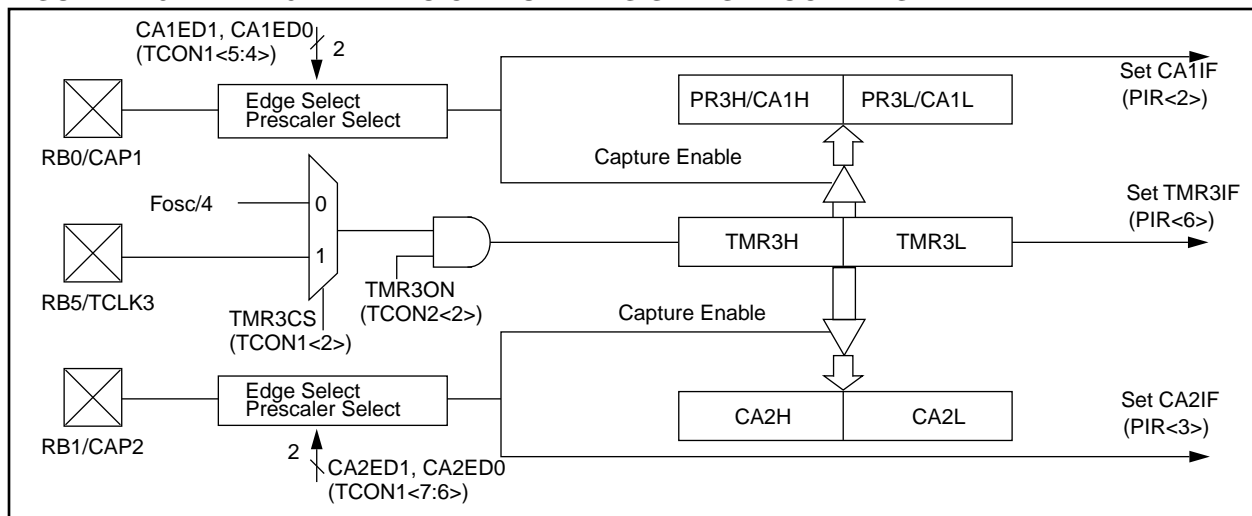


TABLE 12-5: REGISTERS ASSOCIATED WITH CAPTURE

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
16h, Bank 3	TCON1	CA2ED1	CA2ED0	CA1ED1	CA1ED0	T16	TMR3CS	TMR2CS	TMR1CS	0000 0000	0000 0000
17h, Bank 3	TCON2	CA2OVF	CA1OVF	PWM2ON	PWM1ON	CA1/PR3	TMR3ON	TMR2ON	TMR1ON	0000 0000	0000 0000
12h, Bank 2	TMR3L	TMR3 register; low byte								xxxx xxxx	uuuu uuuu
13h, Bank 2	TMR3H	TMR3 register; high byte								xxxx xxxx	uuuu uuuu
16h, Bank 1	PIR	RBIF	TMR3IF	TMR2IF	TMR1IF	CA2IF	CA1IF	TXIF	RCIF	0000 0010	0000 0010
17h, Bank 1	PIE	RBIE	TMR3IE	TMR2IE	TMR1IE	CA2IE	CA1IE	TXIE	RCIE	0000 0000	0000 0000
07h, Unbanked	INTSTA	PEIF	T0CKIF	T0IF	INTF	PEIE	T0CKIE	T0IE	INTE	0000 0000	0000 0000
06h, Unbanked	CPUSTA	—	—	STKAV	GLINTD	T0	PD	—	—	--11 11--	--11 qq--
16h, Bank 2	PR3L/CA1L	Timer3 period register, low byte/capture1 register, low byte								xxxx xxxx	uuuu uuuu
17h, Bank 2	PR3H/CA1H	Timer3 period register, high byte/capture1 register, high byte								xxxx xxxx	uuuu uuuu
14h, Bank 3	CA2L	Capture2 low byte								xxxx xxxx	uuuu uuuu
15h, Bank 3	CA2H	Capture2 high byte								xxxx xxxx	uuuu uuuu

Legend: x = unknown, u = unchanged, — = unimplemented read as '0', q - value depends on condition, shaded cells are not used by Capture.

Note 1: Other (non power-up) resets include: external reset through MCLR and WDT Timer Reset.

14.3 Watchdog Timer (WDT)

The Watchdog Timer's function is to recover from software malfunction. The WDT uses an internal free running on-chip RC oscillator for its clock source. This does not require any external components. This RC oscillator is separate from the RC oscillator of the OSC1/CLKIN pin. That means that the WDT will run, even if the clock on the OSC1/CLKIN and OSC2/CLKOUT pins of the device has been stopped, for example, by execution of a `SLEEP` instruction. During normal operation and SLEEP mode, a WDT time-out generates a device RESET. The WDT can be permanently disabled by programming the configuration bits `WDTPS1:WDTPS0` as '00' (Section 14.1).

Under normal operation, the WDT must be cleared on a regular interval. This time is less the minimum WDT overflow time. Not clearing the WDT in this time frame will cause the WDT to overflow and reset the device.

14.3.1 WDT PERIOD

The WDT has a nominal time-out period of 12 ms, (with postscaler = 1). The time-out periods vary with temperature, V_{DD} and process variations from part to part (see DC specs). If longer time-out periods are desired, a postscaler with a division ratio of up to 1:256 can be assigned to the WDT. Thus, typical time-out periods up to 3.0 seconds can be realized.

The `CLRWDT` and `SLEEP` instructions clear the WDT and the postscaler (if assigned to the WDT) and prevent it from timing out thus generating a device RESET condition.

The \overline{TO} bit in the `CPUSTA` register will be cleared upon a WDT time-out.

14.3.2 CLEARING THE WDT AND POSTSCALER

The WDT and postscaler are cleared when:

- The device is in the reset state
- A `SLEEP` instruction is executed
- A `CLRWDT` instruction is executed
- Wake-up from SLEEP by an interrupt

The WDT counter/postscaler will start counting on the first edge after the device exits the reset state.

14.3.3 WDT PROGRAMMING CONSIDERATIONS

It should also be taken in account that under worst case conditions (V_{DD} = Min., Temperature = Max., max. WDT postscaler) it may take several seconds before a WDT time-out occurs.

The WDT and postscaler is the Power-up Timer during the Power-on Reset sequence.

14.3.4 WDT AS NORMAL TIMER

When the WDT is selected as a normal timer, the clock source is the device clock. Neither the WDT nor the postscaler are directly readable or writable. The overflow time is 65536 T_{OSC} cycles. On overflow, the \overline{TO} bit is cleared (device is not reset). The `CLRWDT` instruction can be used to set the \overline{TO} bit. This allows the WDT to be a simple overflow timer. When in sleep, the WDT does not increment.

FIGURE 14-8: WATCHDOG TIMER BLOCK DIAGRAM

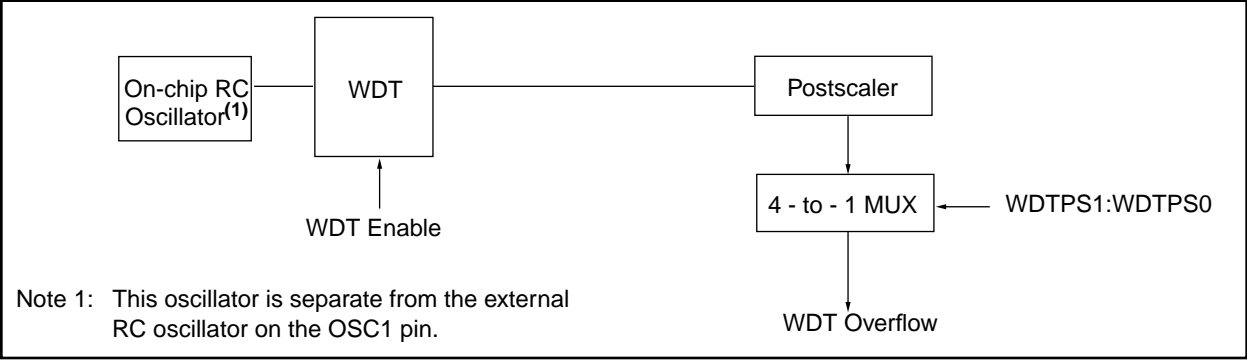


TABLE 14-4: REGISTERS/BITS ASSOCIATED WITH THE WATCHDOG TIMER

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
—	Config	—	PM1	—	PM0	WDTPS1	WDTPS0	FOSC1	FOSC0	(Note 2)	(Note 2)
06h, Unbanked	CPUSTA	—	—	STKAV	GLINTD	T0	PD	—	—	--11 11--	--11 qq--

Legend: — = unimplemented read as '0', q - value depends on condition, shaded cells are not used by the WDT.
Note 1: Other (non power-up) resets include: external reset through MCLR and Watchdog Timer Reset.
2: This value will be as the device was programmed, or if unprogrammed, will read as all '1's.

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MOVFP Move f to p

Syntax: `[label] MOVFP f,p`

Operands: $0 \leq f \leq 255$
 $0 \leq p \leq 31$

Operation: $(f) \rightarrow (p)$

Status Affected: None

Encoding:

011p	pppp	ffff	ffff
------	------	------	------

Description: Move data from data memory location 'f' to data memory location 'p'. Location 'f' can be anywhere in the 256 word data space (00h to FFh) while 'p' can be 00h to 1Fh.

Either 'p' or 'f' can be WREG (a useful special situation).

MOVFP is particularly useful for transferring a data memory location to a peripheral register (such as the transmit buffer or an I/O port). Both 'f' and 'p' can be indirectly addressed.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write register 'p'

Example: `MOVFP REG1, REG2`

Before Instruction

REG1 = 0x33,
REG2 = 0x11

After Instruction

REG1 = 0x33,
REG2 = 0x33

MOVLB Move Literal to low nibble in BSR

Syntax: `[label] MOVLB k`

Operands: $0 \leq k \leq 15$

Operation: $k \rightarrow (\text{BSR}<3:0>)$

Status Affected: None

Encoding:

1011	1000	uuuu	kkkk
------	------	------	------

Description: The four bit literal 'k' is loaded in the Bank Select Register (BSR). Only the low 4-bits of the Bank Select Register are affected. The upper half of the BSR is unchanged. The assembler will encode the "u" fields as '0'.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'u:k'	Execute	Write literal 'k' to BSR<3:0>

Example: `MOVLB 0x5`

Before Instruction

BSR register = 0x22

After Instruction

BSR register = 0x25

Note: For the PIC17C42, only the low four bits of the BSR register are physically implemented. The upper nibble is read as '0'.

XORLW		Exclusive OR Literal with WREG							
Syntax:	[<i>label</i>] XORLW k								
Operands:	0 ≤ k ≤ 255								
Operation:	(WREG) .XOR. k → (WREG)								
Status Affected:	Z								
Encoding:	<table><tr><td>1011</td><td>0100</td><td>kkkk</td><td>kkkk</td></tr></table>					1011	0100	kkkk	kkkk
1011	0100	kkkk	kkkk						
Description:	The contents of WREG are XOR'ed with the 8-bit literal 'k'. The result is placed in WREG.								
Words:	1								
Cycles:	1								
Q Cycle Activity:									
	Q1	Q2	Q3	Q4					
	Decode	Read literal 'k'	Execute	Write to WREG					

Example: XORLW 0xAF

Before Instruction
WREG = 0xB5

After Instruction
WREG = 0x1A

XORWF		Exclusive OR WREG with f						
Syntax:	[<i>label</i>] XORWF f,d							
Operands:	0 ≤ f ≤ 255 d ∈ [0,1]							
Operation:	(WREG) .XOR. (f) → (dest)							
Status Affected:	Z							
Encoding:	<table border="1"><tr><td>0000</td><td>110d</td><td>ffff</td><td>ffff</td></tr></table>				0000	110d	ffff	ffff
0000	110d	ffff	ffff					
Description:	Exclusive OR the contents of WREG with register 'f'. If 'd' is 0 the result is stored in WREG. If 'd' is 1 the result is stored back in the register 'f'.							
Words:	1							
Cycles:	1							
Q Cycle Activity:								
	Q1	Q2	Q3	Q4				
	Decode	Read register 'f'	Execute	Write to destination				

Example: XORWF REG, 1

Before Instruction
REG = 0xAF
WREG = 0xB5

After Instruction
REG = 0x1A
WREG = 0xB5

FIGURE 17-7: CAPTURE TIMINGS

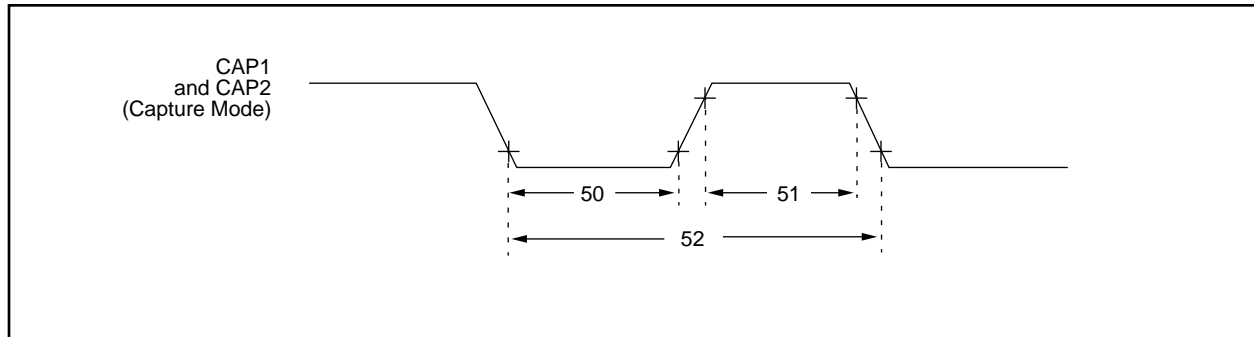


TABLE 17-7: CAPTURE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
50	TccL	Capture1 and Capture2 input low time	10 *	—	—	ns	
51	TccH	Capture1 and Capture2 input high time	10 *	—	—	ns	
52	TccP	Capture1 and Capture2 input period	$\frac{2 T_{CY}}{N}$ §	—	—	ns	N = prescale value (4 or 16)

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

FIGURE 17-8: PWM TIMINGS

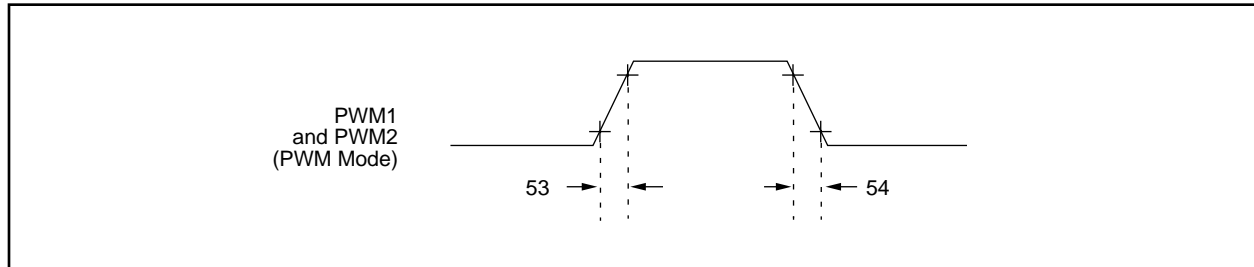


TABLE 17-8: PWM REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
53	TccR	PWM1 and PWM2 output rise time	—	10 *	35 *§	ns	
54	TccF	PWM1 and PWM2 output fall time	—	10 *	35 *§	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

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FIGURE 17-12: MEMORY INTERFACE READ TIMING

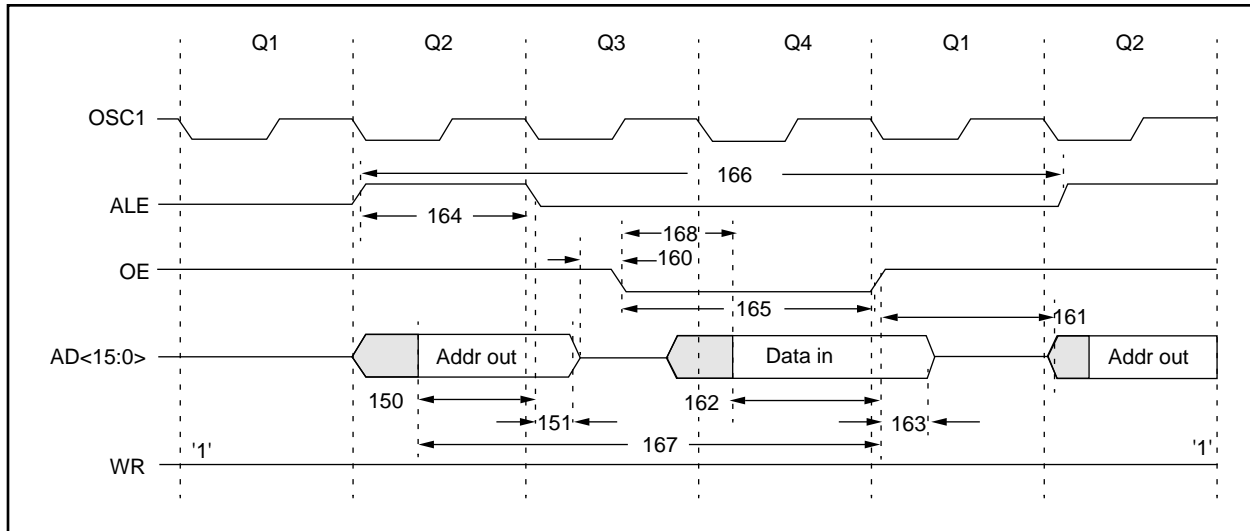


TABLE 17-12: MEMORY INTERFACE READ REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
150	TadV2aL	AD<15:0> (address) valid to ALE↓ (address setup time)	0.25Tcy - 30	—	—	ns	
151	TaL2adI	ALE↓ to address out invalid (address hold time)	5*	—	—	ns	
160	TadZ2oeL	AD<15:0> high impedance to OE↓	0*	—	—	ns	
161	ToeH2adD	OE↑ to AD<15:0> driven	0.25Tcy - 15	—	—	ns	
162	TadV2oeH	Data in valid before OE↑ (data setup time)	35	—	—	ns	
163	ToeH2adI	OE↑ to data in invalid (data hold time)	0	—	—	ns	
164	TaIH	ALE pulse width	—	0.25Tcy §	—	ns	
165	ToeL	OE pulse width	0.5Tcy - 35 §	—	—	ns	
166	TaIH2aIH	ALE↑ to ALE↑ (cycle time)	—	Tcy §	—	ns	
167	Tacc	Address access time	—	—	0.75 Tcy-40	ns	
168	Toe	Output enable access time (OE low to Data Valid)	—	—	0.5 Tcy - 60	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification guaranteed by design.

PIC17C4X

Applicable Devices 42 R42 42A 43 R43 44

FIGURE 20-2: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD

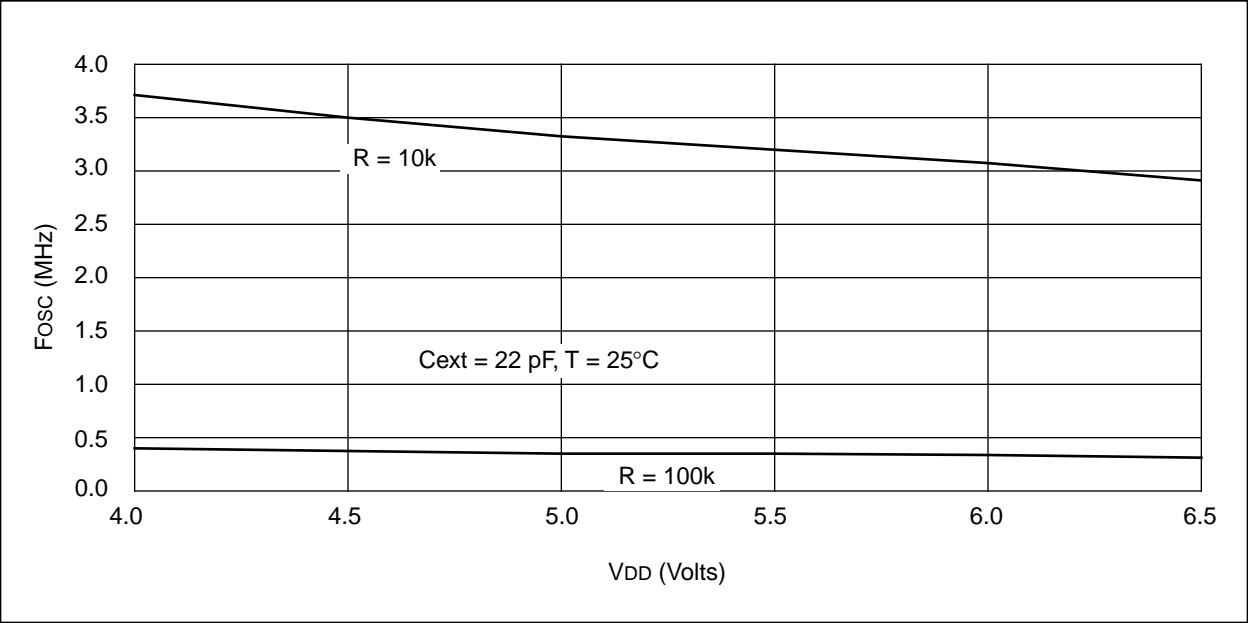


FIGURE 20-3: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD

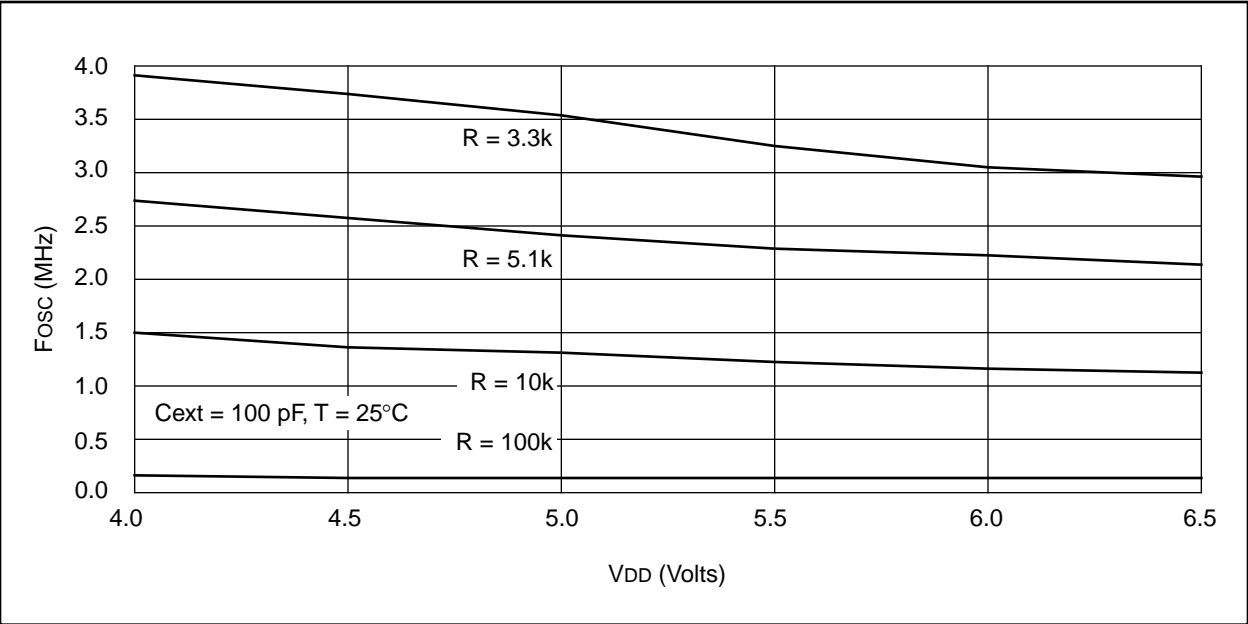


FIGURE 20-7: TYPICAL I_{DD} vs. FREQUENCY (EXTERNAL CLOCK 25°C)

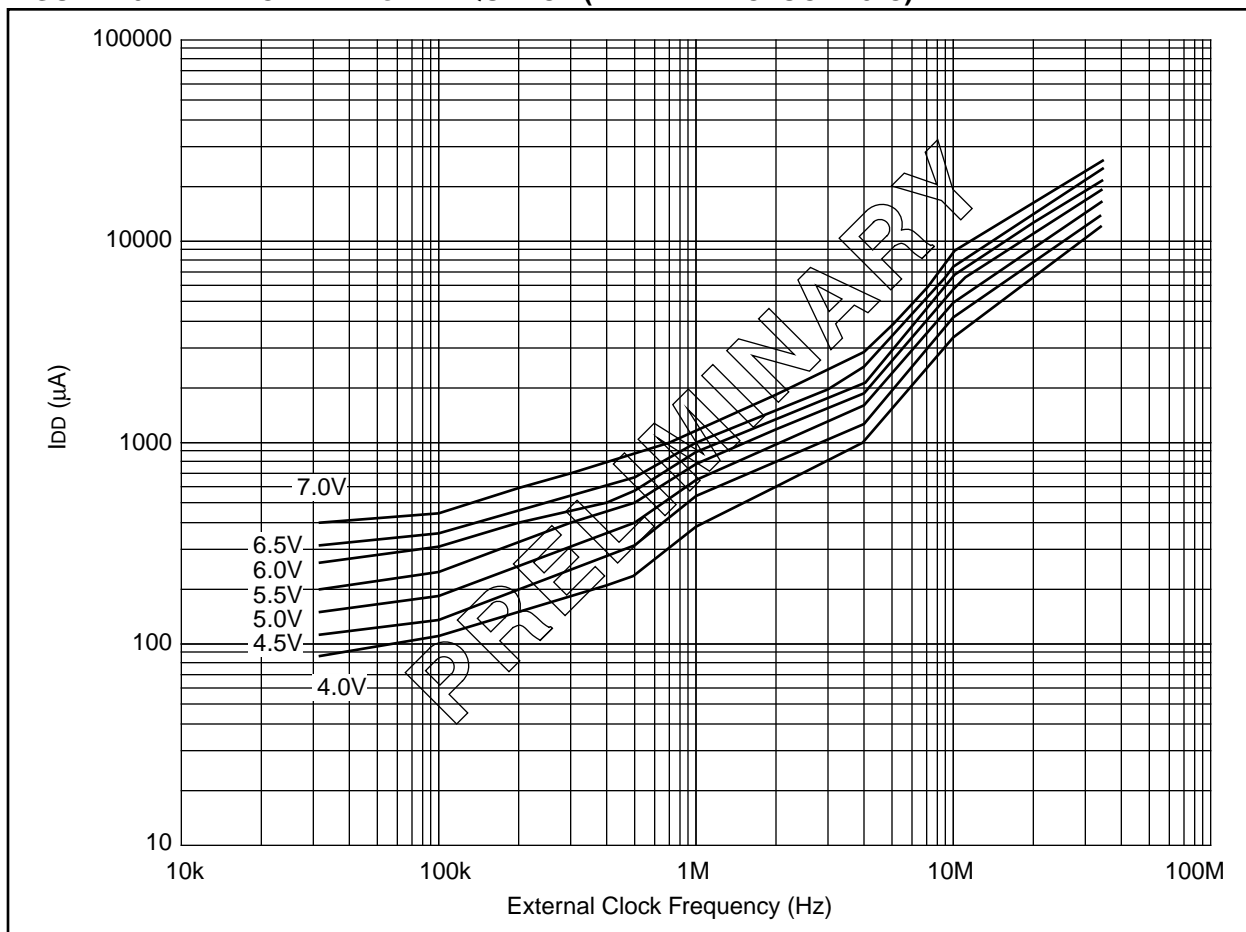
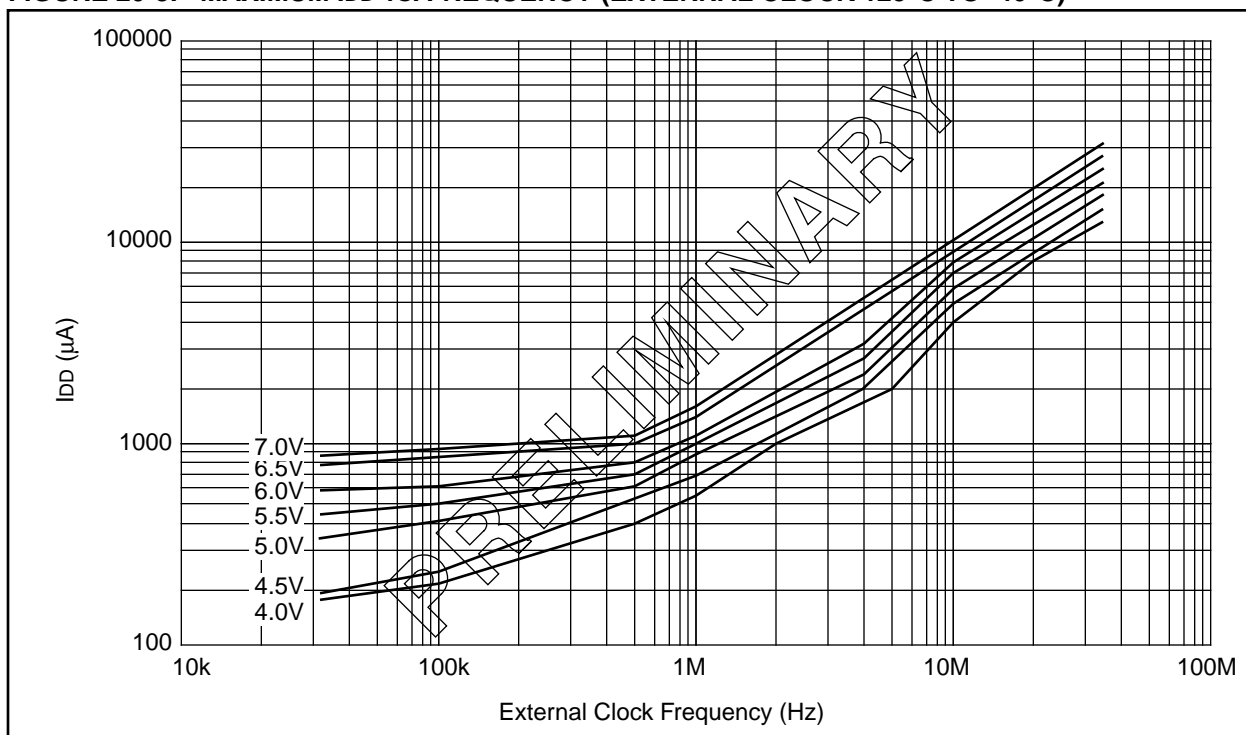
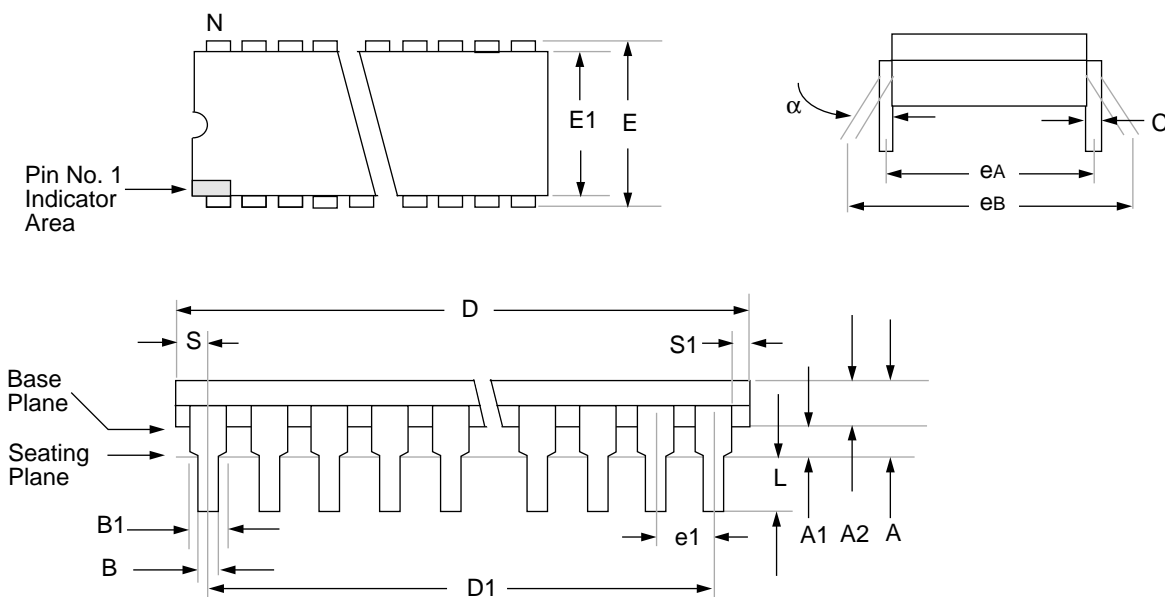


FIGURE 20-8: MAXIMUM I_{DD} vs. FREQUENCY (EXTERNAL CLOCK 125°C TO -40°C)



PIC17C4X

21.2 40-Lead Plastic Dual In-line (600 mil)



Package Group: Plastic Dual In-Line (PLA)						
Symbol	Millimeters			Inches		
	Min	Max	Notes	Min	Max	Notes
α	0°	10°		0°	10°	
A	—	5.080		—	0.200	
A1	0.381	—		0.015	—	
A2	3.175	4.064		0.125	0.160	
B	0.355	0.559		0.014	0.022	
B1	1.270	1.778	Typical	0.050	0.070	Typical
C	0.203	0.381	Typical	0.008	0.015	Typical
D	51.181	52.197		2.015	2.055	
D1	48.260	48.260	Reference	1.900	1.900	Reference
E	15.240	15.875		0.600	0.625	
E1	13.462	13.970		0.530	0.550	
e1	2.489	2.591	Typical	0.098	0.102	Typical
eA	15.240	15.240	Reference	0.600	0.600	Reference
eB	15.240	17.272		0.600	0.680	
L	2.921	3.683		0.115	0.145	
N	40	40		40	40	
S	1.270	—		0.050	—	
S1	0.508	—		0.020	—	

PIC17C4X

E.6 PIC16C8X Family of Devices

	Clock			Memory			Peripherals		Features		
	Maximum Frequency of Operation (MHz)			Program Memory			Timer Modules				
	Flash	EEPROM	ROM	Data Memory (bytes)	Data EEPROM (bytes)	Interrupt Sources	I/O Pins	Voltage Range (Volts)	Packages		
PIC16C84	10	—	1K	—	36	64	TMR0	4	13	2.0-6.0	18-pin DIP, SOIC
PIC16F84 ⁽¹⁾	10	1K	—	—	68	64	TMR0	4	13	2.0-6.0	18-pin DIP, SOIC
PIC16CR84 ⁽¹⁾	10	—	—	1K	68	64	TMR0	4	13	2.0-6.0	18-pin DIP, SOIC
PIC16F83 ⁽¹⁾	10	512	—	—	36	64	TMR0	4	13	2.0-6.0	18-pin DIP, SOIC
PIC16CR83 ⁽¹⁾	10	—	—	512	36	64	TMR0	4	13	2.0-6.0	18-pin DIP, SOIC

All PIC16/17 family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect, and high I/O current capability.

All PIC16C8X family devices use serial programming with clock pin RB6 and data pin RB7.

Note 1: Please contact your local sales office for availability of these devices.

E.7 PIC16C9XX Family Of Devices

	Clock		Memory		Peripherals							Features				
	8	4K	176	TMR0, TMR1, TMR2	1	SPI/I ² C	—	4 Com 32 Seg	8	25	27	3.0-6.0	Yes	—		
PIC16C923														64-pin SDIP(1), TQFP, 68-pin PLCC, DIE		
PIC16C924	8	4K	176	TMR0, TMR1, TMR2	1	SPI/I ² C	—	5	4 Com 32 Seg	9	25	27	3.0-6.0	Yes	—	64-pin SDIP(1), TQFP, 68-pin PLCC, DIE

All PIC16/17 Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability.

All PIC16CXX Family devices use serial programming with clock pin RB6 and data pin RB7.

Note 1: Please contact your local Microchip representative for availability of this package.

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